

TS4984

2 x 1W Stereo audio power amplifier with active low standby mode

- Operating from V_{CC}=2.2V to 5.5V
- 1W output power per channel @ V_{CC}=5V, THD+N=1%, RL=8Ω
- 10nA standby current
- 62dB PSRR @ 217Hz with grounded inputs
- High SNR: 100dB(A) typ.
- Near-zero pop & click
- Available in QFN16 4x4 mm, 0.5mm pitch, leadfree package

Description

The TS4984 has been designed for top of the class stereo audio applications. Thanks to its compact and power dissipation efficient QFN package, it suits various applications.

With a BTL configuration, this Audio Power Amplifier is capable of delivering 1W per channel of continuous RMS output power into an 8Ω load @ 5V.

An externally controlled standby mode control reduces the supply current to less than 10nA per channel. The device also features an internal thermal shutdown protection.

The gain of each channel can be configured by external gain setting resistors.

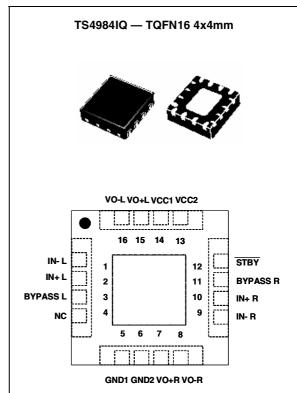
Applications

- Cellular mobile phones
- Notebook computers & PDAs

Order Codes

Part Number	Temperature Range	Package	Packaging	Marking
TS4984IQT	-40, +85°C	QFN	Tape & Reel	K984





■ LCD monitors & TVs

Portable audio devices

TS4984

1 Typical Application

Figure 1 shows a schematic view of a typical audio amplification application using the TS4984. *Table 1* describes the components used in this typical application.

Figure 1: Typical application schematic

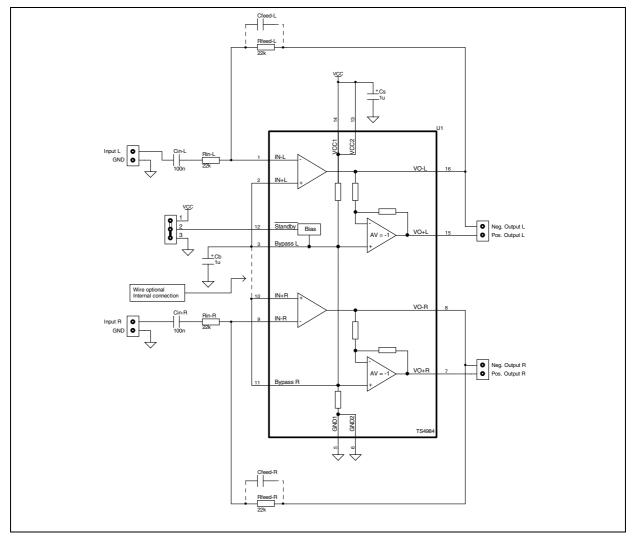


Table 1: External component descriptions

Components	Functional Description	
R _{IN L,R}	Inverting input resistors which sets the closed loop gain in conjunction with R_{feed} . These resistors also form a high pass filter with C_{IN} ($fc = 1 / (2 \times Pi \times R_{IN} \times C_{IN})$).	
C _{IN L,R} Input coupling capacitors which blocks the DC voltage at the amplifier input terminal.		
R _{FEED L,R}	Feedback resistors which sets the closed loop gain in conjunction with R_{IN} .	
C _S	Supply Bypass capacitor which provides power supply filtering.	
C _B	Bypass pin capacitor which provides half supply filtering.	
A _{V L, R}	Closed loop gain in BTL configuration = $2 \times (R_{FEED} / R_{IN})$ on each channel.	

2 Absolute maximum ratings and operating conditions

Table 2: Key parameters and their absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{cc}	Supply voltage ¹	6	V
Vi	Input Voltage ²	GND to V _{CC}	V
T _{oper}	Operating Free Air Temperature Range	-40 to + 85	°C
T _{stg}	Storage Temperature	-65 to +150	°C
Тj	Maximum Junction Temperature	150	°C
R _{thja}	Thermal Resistance Junction to Ambient QFN16	120	°C/W
Pd	Power Dissipation	Internally Limited	
ESD	Human Body Model ³	2	kV
ESD	Machine Model	200	V
	Latch-up Immunity	200mA	

1) All voltages values are measured with respect to the ground pin

2) The magnitude of input signal must never exceed V_{CC} + 0.3V / GND - 0.3V

3) The voltage value is measured with respect from pin to supply

Table 3: Operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	2.2 to 5.5	V
VICM	Common Mode Input Voltage Range	1.2V to V _{CC}	V
V _{STB}	Standby Voltage Input: Device ON Device OFF	$1.35 \le V_{STB} \le V_{CC}$ GND $\le V_{STB} \le 0.4$	v
RL	Load Resistor	≥ 4	Ω
R _{OUTGND}	Resistor Output to GND (V _{STB} = GND)	≥1	MΩ
T _{SD}	Thermal Shutdown Temperature	150	°C
R _{THJA}	Thermal Resistance Junction to Ambient QFN16 ¹ QFN16 ²	45 85	°C/W

1) When mounted on a 4-layer PCB with via

2) When mounted on a 2 layer PCB

3 Electrical characteristics

Table 4: Electrical characteristics for V_{CC} = +5V, GND = 0V, T_{amb} = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{CC}	Supply Current No input signal, no load		7.4	12	mA
ISTANDBY	Standby Current ¹ No input signal, Vstdby = G_{ND} , RL = 8 Ω		10	1000	nA
Voo	Output Offset Voltage No input signal, RL = 8Ω		1	10	mV
P _{out}	Output Power THD = 1% Max, F = 1kHz, RL = 8Ω	0.8	1		W
THD + N	D + N Total Harmonic Distortion + Noise Po = 1Wrms, Av = 2, 20Hz \leq F \leq 20kHz, RL = 8 Ω		0.2		%
PSRR	$ \begin{array}{l} \mbox{Power Supply Rejection Ratio}^2 \\ \mbox{RL} = 8\Omega, \mbox{Av} = 2, \mbox{Vripple} = 200 \mbox{mVpp, Input Grounded} \\ \mbox{F} = 217 \mbox{Hz} \\ \mbox{F} = 1 \mbox{Hz} \end{array} $		62 64		dB
Crosstalk	Channel Separation, $R_L = 8\Omega$ F = 1kHz F = 20Hz to 20kHz		-92 -70		dB
Τ _{WU}	Wake-Up Time (Cb = 1µF)		90	130	ms
T _{STDB}	Standby Time (Cb = 1µF)		10		μs
V _{STDBH}	Standby Voltage Level High			1.3	V
V _{STDBL}	Standby Voltage Level Low			0.4	V
Φ_{M}	Phase Margin at Unity Gain $R_L = 8\Omega$, $C_L = 500 pF$		65		Degrees
GM	Gain Margin $R_L = 8\Omega, C_L = 500pF$		15		dB
GBP	Gain Bandwidth Product $R_L = 8\Omega$		1.5		MHz

1) Standby mode is activated when Vstdby is tied to Gnd.

All PSRR data limits are guaranteed by production sampling tests Dynamic measurements - 20*log(rms(Vout)/rms(Vripple)). Vripple is the sinusoidal signal superimposed upon Vcc.

Table 5: Electrical characteristics for V_{CC} = +3.3V, GND = 0V, T_{amb} = 25°C (unless otherwise specified)

Symbol	Parameter		Тур.	Max.	Unit
I _{CC}	Supply Current No input signal, no load		6.6	12	mA
ISTANDBY	Standby Current ¹ No input signal, Vstdby = G_{ND} , RL = 8 Ω		10	1000	nA
Voo	$\begin{array}{c c} & & & & \\ Output Offset Voltage \\ No input signal, RL = 8\Omega \end{array} \hspace{1cm} 1 \hspace{1cm} 10 \end{array}$		mV		
P _{out}	Output Power THD = 1% Max, F = 1kHz, RL = 8Ω 300450			mW	
THD + N	+ N Total Harmonic Distortion + Noise Po = 400mWrms, Av = 2, 20Hz \leq F \leq 20kHz, RL = 8 Ω 0.		0.1		%
PSRR	Power Supply Rejection Ratio ² RL = 8Ω , Av = 2, Vripple = 200mVpp, Input Grounded F = 217Hz F = 1kHz	55 55	61 63		dB
Crosstalk	Channel Separation, $R_L = 8\Omega$ F = 1kHz F = 20Hz to 20kHz		-94 -68		dB
Τ _{WU}	Wake-Up Time (Cb = 1µF)		110	140	ms
T _{STDB}	Standby Time (Cb = 1µF)		10		μs
V _{STDBH}	Standby Voltage Level High			1.2	V
V _{STDBL}	BL Standby Voltage Level Low		0.4	V	
Φ_{M}	Phase Margin at Unity Gain $R_L = 8\Omega$, $C_L = 500 pF$		65		Degrees
GM	$ \begin{array}{ c c c } \mbox{Gain Margin} & & & & \\ \mbox{R}_L = 8\Omega, C_L = 500 \mbox{pF} & & & \\ \end{tabular} $		dB		
GBP	Gain Bandwidth Product $R_L = 8\Omega$		1.5		MHz

1) Standby mode is activated when Vstdby is tied to Gnd

All PSRR data limits are guaranteed by production sampling tests Dynamic measurements - 20*log(rms(Vout)/rms(Vripple)). Vripple is the sinusoidal signal superimposed upon Vcc.

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Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{CC}	Supply Current No input signal, no load		6.2	12	mA
I _{STANDBY}	Standby Current ¹ No input signal, Vstdby = G_{ND} , RL = 8 Ω		10	1000	nA
Voo	$\begin{array}{c c} & & & & \\$		mV		
Pout	Output Power THD = 1% Max, F = 1kHz, RL = 8 Ω 200250			mW	
THD + N	$ \begin{array}{c c} \mbox{Total Harmonic Distortion + Noise} \\ \mbox{Po = 200mWrms, Av = 2, 20Hz \le F \le 20kHz, RL = 8\Omega } \end{array} \\ \hline \end{tabular} 0.1 $			%	
PSRR	Power Supply Rejection Ratio ² RL = 8Ω , Av = 2, Vripple = 200mVpp, Input Grounded F = 217Hz F = 1kHz	55 55	60 62		dB
Crosstalk	Channel Separation, $R_L = 8\Omega$ F = 1kHz F = 20Hz to 20kHz		-95 -68		dB
Τ _{WU}	Wake-Up Time (Cb = 1µF)		125	150	ms
T _{STDB}	Standby Time (Cb = 1µF)		10		μs
V _{STDBH}	Standby Voltage Level High			1.2	V
V _{STDBL}	Standby Voltage Level Low			0.4	V
Φ_{M}	Phase Margin at Unity Gain $R_L = 8\Omega, C_L = 500 pF$ 65			Degrees	
GM	$ \begin{array}{c} \mbox{Gain Margin} \\ \mbox{R}_L = 8\Omega, \mbox{C}_L = 500 \mbox{pF} \end{array} $		dB		
GBP	Gain Bandwidth Product $R_L = 8\Omega$		1.5		MHz

Table 6: Electrical characteristics for V_{CC} = +2.6V, GND = 0V, T_{amb} = 25°C (unless otherwise specified)

1) Standby mode is activated when Vstdby is tied to Gnd

All PSRR data limits are guaranteed by production sampling tests Dynamic measurements - 20*log(rms(Vout)/rms(Vripple)). Vripple is the sinusoidal signal superimposed upon Vcc.

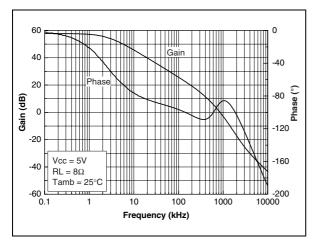


Figure 2: Open loop frequency response



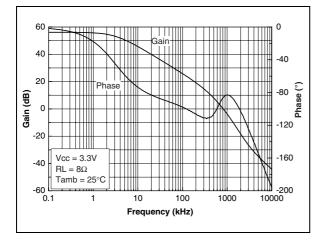


Figure 4: Open loop frequency response

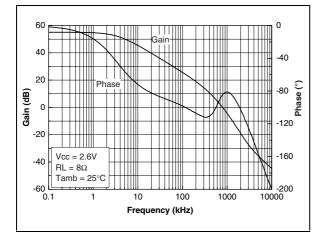


Figure 5: Open loop frequency response

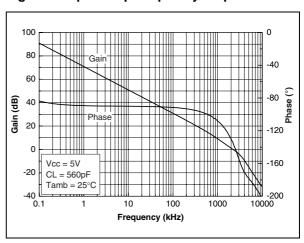


Figure 6: Open loop frequency response

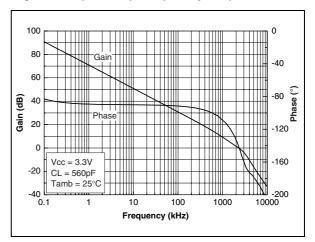


Figure 7: Open loop frequency response

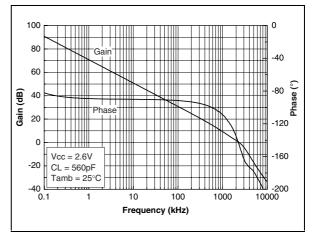


Figure 8: Power supply rejection ratio (PSRR) vs. frequency

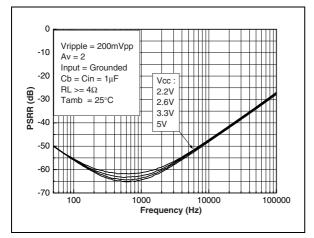


Figure 9: Power supply rejection ratio (PSRR) vs. frequency

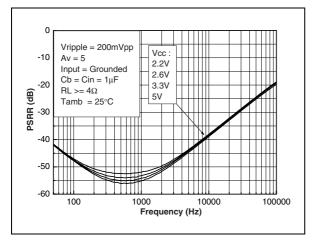


Figure 10: Power supply rejection ratio (PSRR) vs. frequency

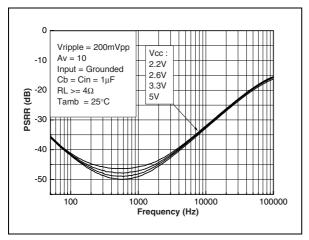


Figure 11: Power supply rejection ratio (PSRR) vs. frequency

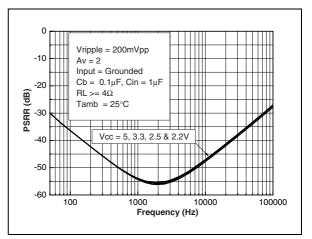


Figure 12: Power supply rejection ratio (PSRR) vs. frequency

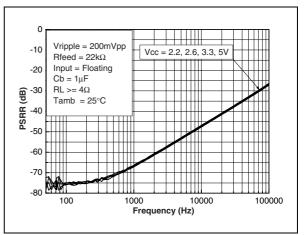
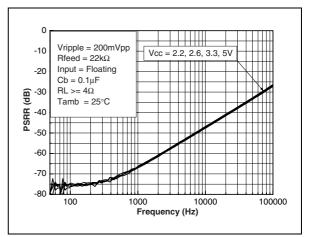


Figure 13: Power supply rejection ratio (PSRR) vs. frequency



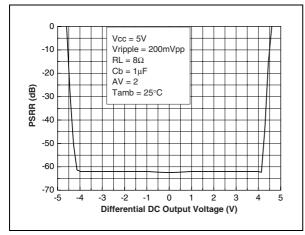


Figure 14: Power supply rejection ratio (PSRR) vs. DC output voltage

Figure 15: Power supply rejection ratio (PSRR) vs. DC output voltage

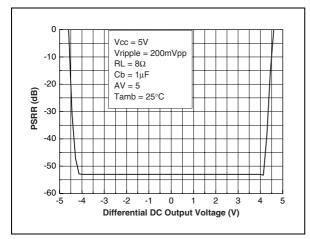
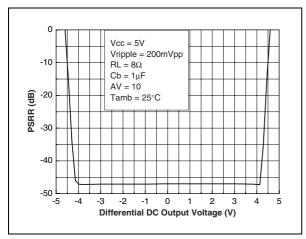
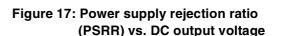


Figure 16: Power supply rejection ratio (PSRR) vs. DC output voltage





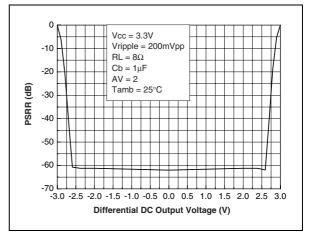


Figure 18: Power supply rejection ratio (PSRR) vs. DC output voltage

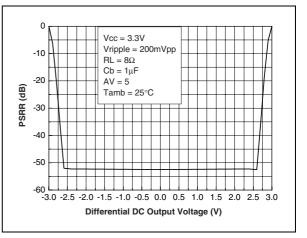
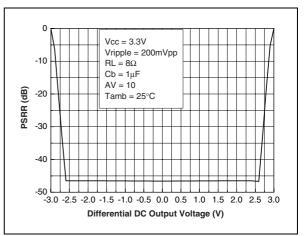


Figure 19: Power supply rejection ratio (PSRR) vs. DC output voltage



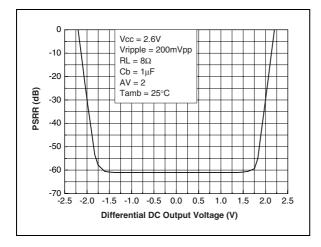


Figure 20: Power supply rejection ratio (PSRR) vs. DC output voltage

Figure 21: Power supply rejection ratio (PSRR) vs. DC output voltage

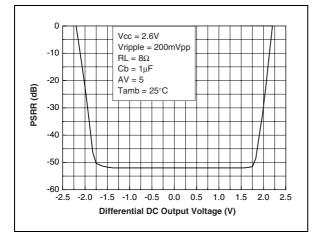
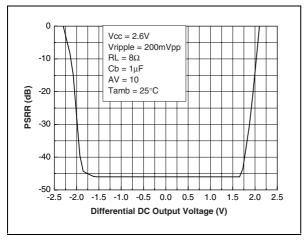


Figure 22: Power supply rejection ratio (PSRR) vs. DC output voltage



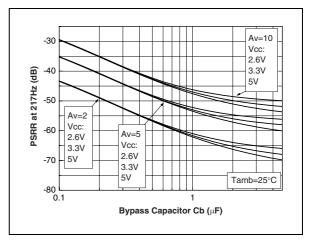
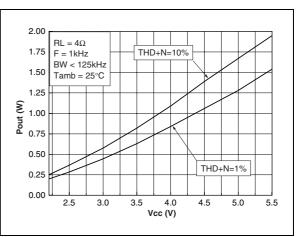
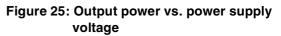


Figure 24: Output power vs. power supply voltage





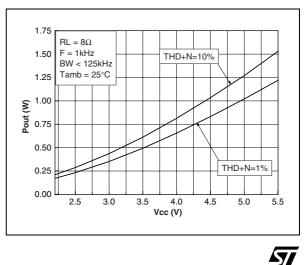


Figure 26: Output power vs. power supply voltage

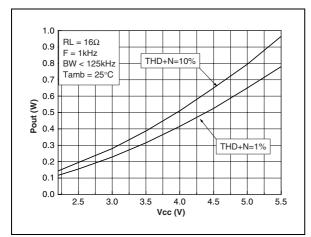


Figure 27: Output power vs. power supply voltage

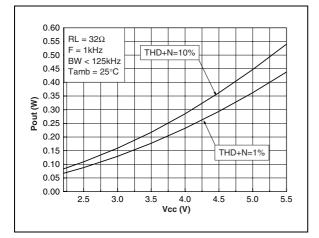


Figure 28: Output power vs. load resistor

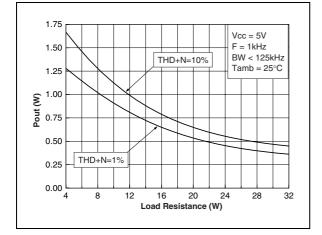


Figure 29: Output power vs. load resistor

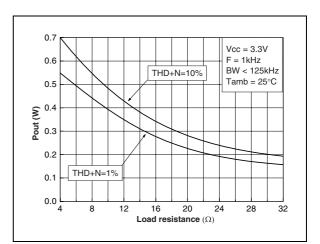


Figure 30: Output power vs. load resistor

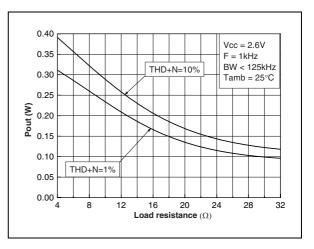
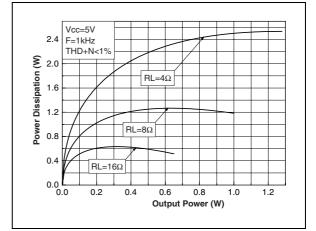


Figure 31: Power dissipation vs. output power



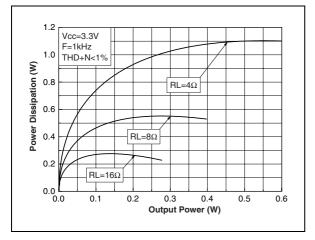


Figure 32: Power dissipation vs. output power

Figure 35: Clipping voltage vs. power supply voltage and load resistor

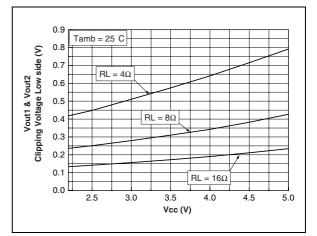


Figure 36: Current consumption vs. power supply voltage

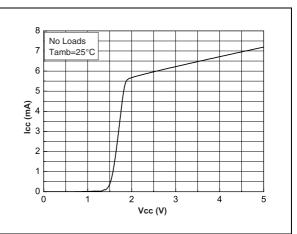


Figure 37: Current consumption vs. standby voltage at Vcc=5V

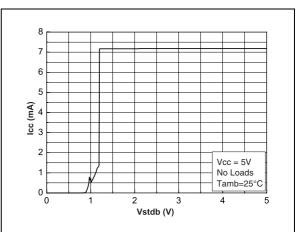


Figure 33: Power dissipation vs. output power

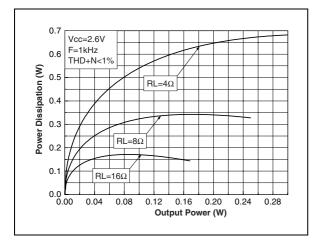
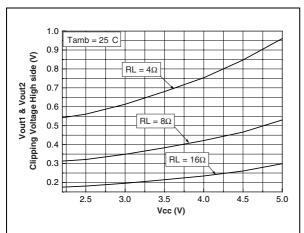


Figure 34: Clipping voltage vs. power supply voltage and load resistor



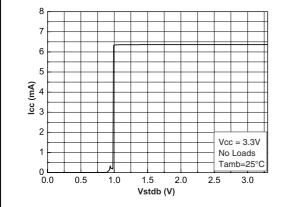


Figure 39: Current consumption vs. standby voltage at Vcc=2.6V

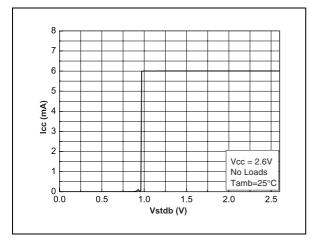


Figure 40: Current consumption vs. standby voltage at Vcc=2.2V

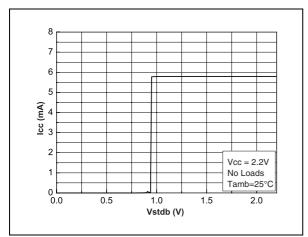


Figure 41: THD+N vs. output power

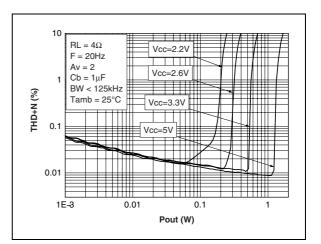


Figure 42: THD+N vs. output power

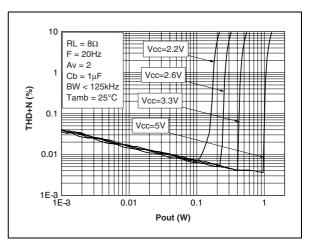


Figure 43: THD+N vs. output power

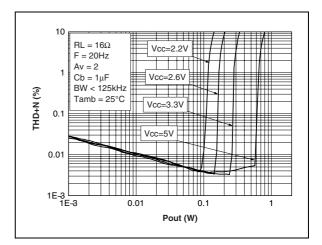


Figure 44: THD+N vs. output power

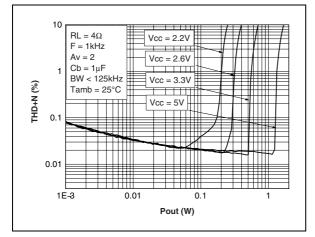


Figure 45: THD+N vs. output power

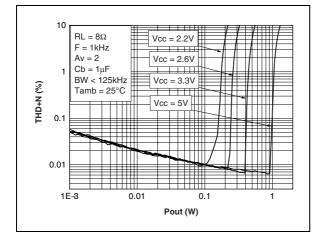


Figure 46: THD+N vs. output power

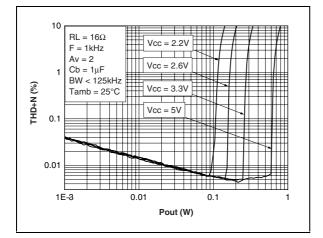


Figure 47: THD+N vs. output power

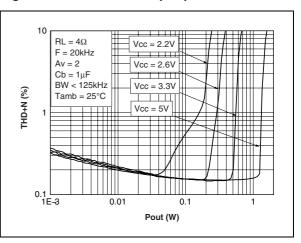


Figure 48: THD+N vs. output power

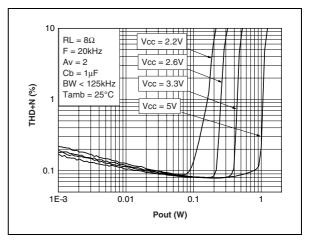
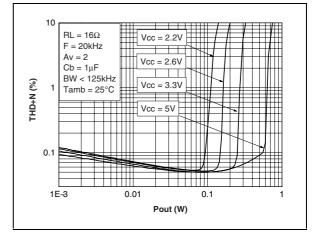


Figure 49: THD+N vs. output power



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Figure 50: THD+N vs. frequency

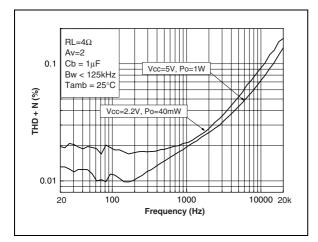


Figure 51: THD+N vs. frequency

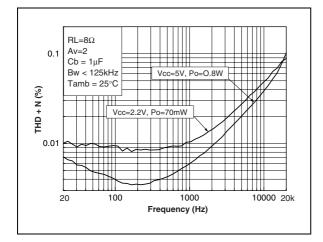


Figure 52: THD+N vs. frequency

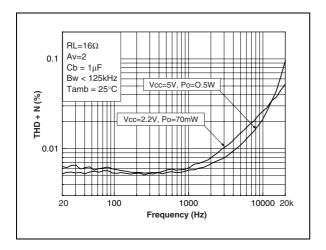


Figure 53: Signal to noise ratio vs. power supply with unweighted filter (20Hz to 20kHz)

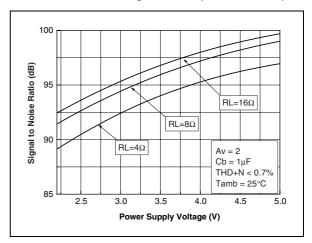


Figure 54: SIgnal to noise ratio vs. pwr supply with unweighted filter (20Hz to 20kHz)

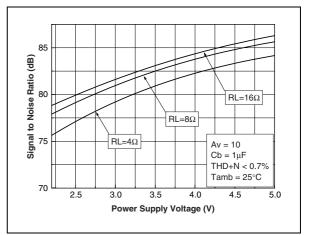
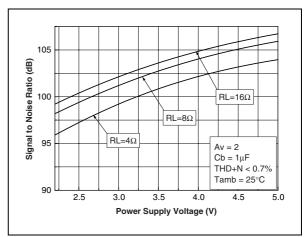


Figure 55: SIgnal to noise ratio vs. power supply with A weighted filter



TS4984

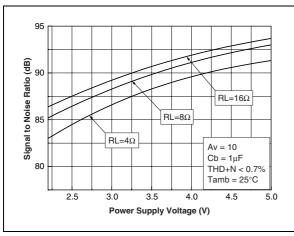


Figure 56: SIgnal to noise ratio vs. power supply with A weighted filter

Figure 57: Crosstalk vs. frequency

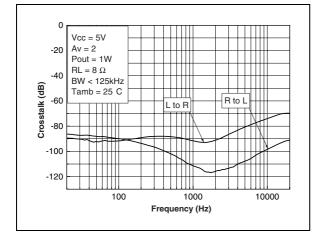


Figure 58: Crosstalk vs. frequency

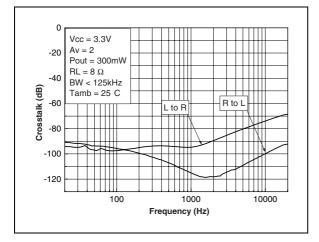


Figure 59: Crosstalk vs. frequency

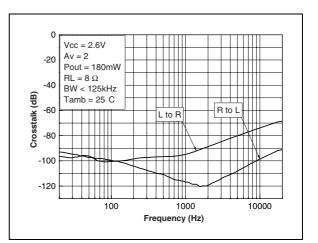


Figure 60: Crosstalk vs. frequency

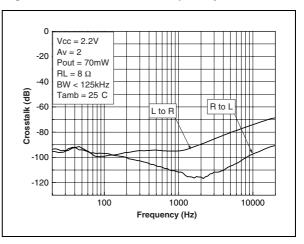
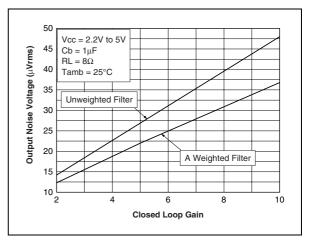


Figure 61: Output noise voltage, device ON



S7

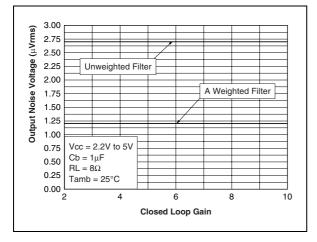
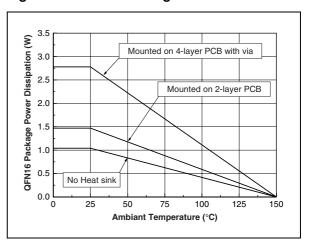


Figure 63: Power derating curves



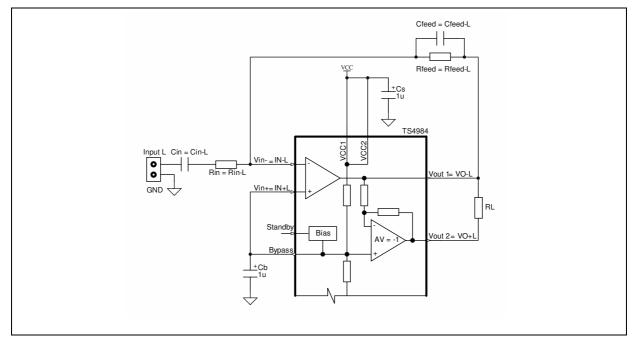
4 Application Information

The TS4984 integrates two monolithic power amplifiers with a BTL (Bridge Tied Load) output type (explained in more detail in *Section 4.1*). For this discussion, only the left-channel amplifier will be referred to.

Referring to the schematic in *Figure 64*, we assign the following variables and values:

 $V_{in} = IN-L$ $V_{out1} = VO-L, V_{out2} = VO+R$ $R_{in} = Rin-L, R_{feed} = Rfeed-L$ $C_{feed} = Cfeed-L$

Figure 64: Typical application schematic - left channel



4.1 BTL configuration principle

BTL (Bridge Tied Load) means that each end of the load is connected to two single-ended output amplifiers. Thus, we have:

Single-ended output $1 = V_{out1} = V_{out}$ (V), Single-ended output $2 = V_{out2} = -V_{out}$ (V), $V_{out1} - V_{out2} = 2V_{out}$ (V)

The output power is:

$$P_{out} = \frac{\left(2V_{outRMS}\right)^2}{R_l}$$

For the same power supply voltage, the output power in a BTL configuration is four times higher than the output power in a single-ended configuration.



4.2 Gain in typical application schematic

The typical application schematic (*Figure 64*) is shown on *page 18*.

In the flat region (no C_{in} effect), the output voltage of the first stage is:

$$V_{out1} = (-V_{in}) \frac{R_{feed}}{R_{in}}$$
 (V)

For the second stage: $V_{out2} = -V_{out1}$ (V)

The differential output voltage is:

$$V_{out2} - V_{out1} = 2V_{in} \frac{R_{feed}}{R_{in}}$$
 (V)

The differential gain, referred to as G_{ν} for greater convenience, is:

$$G_{V} = \frac{V_{out2} - V_{out1}}{V_{in}} = 2\frac{R_{feed}}{R_{in}}$$

 V_{out2} is in phase with V_{in} and V_{out1} is phased 180° with V_{in} . This means that the positive terminal of the loudspeaker should be connected to V_{out2} and the negative to V_{out1} .

4.3 Low and high frequency response

In the low frequency region, C_{in} starts to have an effect. C_{in} forms with R_{in} a high-pass filter with a -3dB cut-off frequency:

$$F_{CL} = \frac{1}{2\pi R_{in}C_{in}} \quad (Hz)$$

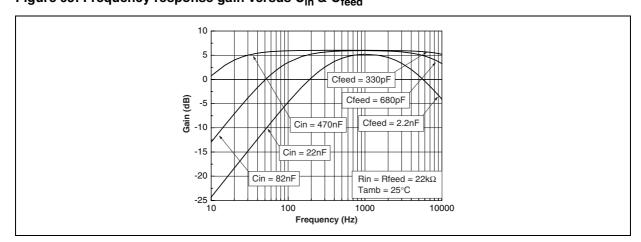
In the high frequency region, you can limit the bandwidth by adding a capacitor (C_{feed}) in parallel with R_{feed} . It forms a low-pass filter with a -3dB cut-off frequency. F_{CH} is in Hz.

$$F_{CH} = \frac{1}{2\pi R_{feed} C_{feed}} \quad (Hz)$$

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TS4984

The following graph (*Figure 65*) shows an example of C_{in} and C_{feed} influence. Figure 65: Frequency response gain versus $C_{in} \& C_{feed}$



4.4 Power dissipation and efficiency

Hypotheses:

- Voltage and current in the load are sinusoidal (V $_{out}$ and I_{out}).
- Supply voltage is a pure DC source (V $_{\rm cc}).$

Regarding the load we have:

$$V_{out} = V_{PEAK} \sin\omega t$$
 (V)

and

$$I_{out} = \frac{V_{out}}{R_L} \qquad (A)$$

and

$$P_{out} = \frac{V_{PEAK}^2}{2R_L} \qquad (W)$$

Therefore, the average current delivered by the supply voltage is:

$$I_{CC_{AVG}} = 2 \frac{V_{PEAK}}{\pi R_L}$$
(A)

The power delivered by the supply voltage is:

$$P_{supply} = V_{CC} \cdot I_{CC_{AVG}}$$
(W)

Then, the power dissipated by each amplifier is:

$$P_{diss} = P_{supply} - P_{out} \qquad (W)$$

$$P_{diss} = \frac{2\sqrt{2}V_{CC}}{\pi\sqrt{R_L}} \cdot \sqrt{P_{out}} - P_{out} \qquad (W)$$

and the maximum value is obtained when:

$$\frac{\partial P_{diss}}{\partial P_{out}} = 0$$

and its value is:

$$P_{dissmax} = \frac{2V_{cc}^2}{\pi^2 R_I} \qquad (W)$$

Note: This maximum value is only depending on power supply voltage and load values. The **efficiency**, η , is the ratio between the output power and the power supply:

$$\eta = \frac{P_{out}}{P_{supply}} = \frac{\pi V_{PEAK}}{4V_{CC}}$$

The maximum theoretical value is reached when $V_{PEAK} = V_{CC}$, so that:

$$\frac{\pi}{4} = 78.5\%$$

The TS4984 has two independent power amplifiers, and each amplifier produces heat due to its power dissipation. Therefore, the maximum die temperature is the sum of the each amplifier's maximum power dissipation. It is calculated as follows:

 $P_{diss L}$ = Power dissipation due to the left channel power amplifier.

 $P_{diss R}$ = Power dissipation due to the right channel power amplifier.

$$Total P_{diss} = P_{diss L} + P_{diss R}$$
(W)

In most cases, $P_{diss L} = P_{diss R}$, giving:

or, stated differently:

Total
$$P_{diss} = \frac{4\sqrt{2}V_{CC}}{\pi\sqrt{R_L}}\sqrt{P_{out}} - 2P_{out}$$
 (W)

4.5 Decoupling the circuit

Two capacitors are needed to correctly bypass the TS4984. A power supply bypass capacitor C_S and a bias voltage bypass capacitor C_B .

 C_S has particular influence on the THD+N in the high frequency region (above 7 kHz) and an indirect influence on power supply disturbances. With a value for C_S of 1 µF, you can expect similar THD+N performances to those shown in the datasheet. For example:

- In the high frequency region, if C_S is lower than 1 μF, it increases THD+N and disturbances on the power supply rail are less filtered.
- On the other hand, if C_S is higher than 1 μF, those disturbances on the power supply rail are more filtered.

 C_b has an influence on THD+N at lower frequencies, but its function is critical to the final result of PSRR (with input grounded and in the lower frequency region), in the following manner:

- If C_b is lower than 1µF, THD+N increases at lower frequencies and PSRR worsens.
- If C_b is higher than 1µF, the benefit on THD+N at lower frequencies is small, but the benefit to PSRR is substantial.

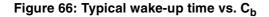
Note that C_{in} has a non-negligible effect on PSRR at lower frequencies. The lower the value of C_{in} , the higher the PSRR.

4.6 Wake-up time, T_{WU}

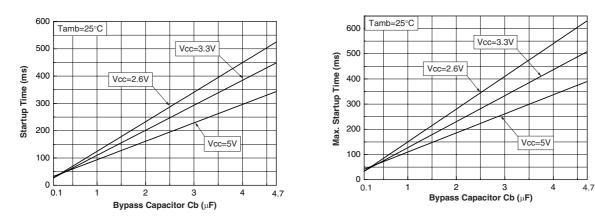
When the standby is released to put the device ON, the bypass capacitor C_b will not be charged immediately. As C_b is directly linked to the bias of the amplifier, the bias will not work properly until the C_b voltage is correct. The time to reach this voltage is called wake-up time or T_{WU} and specified in electrical characteristics table with $C_b = 1 \ \mu\text{F}$.

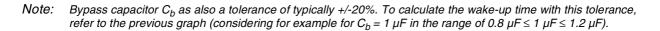
If C_b has a value other than 1 μ F, please refer to the graph in *Figure 66* to establish the wake-up time value.

Due to process tolerances, the maximum value of wake-up time could be establish by the graph in *Figure 67*.











Application Information

4.7 Shutdown time

When the standby command is set, the time required to put the two output stages in high impedance and the internal circuitry in shutdown mode is a few microseconds.

Note: In shutdown mode, Bypass pin and Vin- pin are short-circuited to ground by internal switches. This allows for the quick discharge of the C_b and C_{in} capacitors.

4.8 Pop performance

Pop performance is intimately linked with the size of the input capacitor C_{in} and the bias voltage bypass capacitor C_{b} .

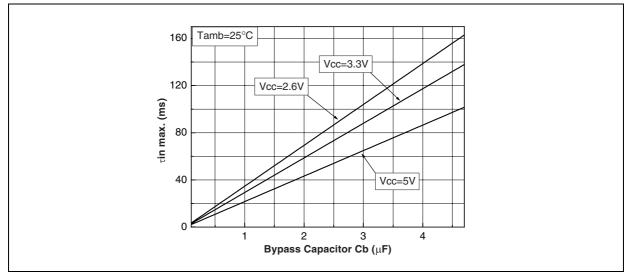
The size of C_{in} is dependent on the lower cut-off frequency and PSRR values requested. The size of C_b is dependent on THD+N and PSRR values requested at lower frequencies.

Moreover, C_b determines the speed with which the amplifier turns ON. In order to reach near zero pop and click, the equivalent input constant time is:

$$t_{in} = (Rin + 2 k\Omega) \times C_{in} (s)$$
 with $R_{in} \ge 5 k\Omega$

must not reach the τ_{in} maximum value as indicated in the graph below in *Figure 68*.

Figure 68: τ_{in} max. versus bypass capacitor



By following previous rules, the TS4984 can reach near zero pop and click even with high gains such as 20 dB.

Example calculation

With $R_{in} = 22 \text{ k}\Omega$ and a 20 Hz, -3 db low cut-off frequency, $C_{in} = 361 \text{ nF}$. So, $C_{in} = 390 \text{ nF}$ with standard value which gives a lower cut-off frequency equal to 18.5 Hz. In this case, $(R_{in} + 2 \text{ k}\Omega) \times C_{in} = 9.36 \text{ ms}$. When referring to the previous graph, if $C_b = 1 \mu \text{F}$ and Vcc = 5 V, we read 20 ms max. This value is twice as high as our current value, thus we can state that pop and click will be reduced to its lowest value. Minimizing both C_{in} and the gain benefits both the pop phenomena, and the cost and size of the application.

4.9 Application example: Differential-input BTL power stereo amplifier

The schematic in *Figure 69* shows how to design the TS4984 to work in differential-input mode. For this discussion, only the left-channel amplifier will be referred to.

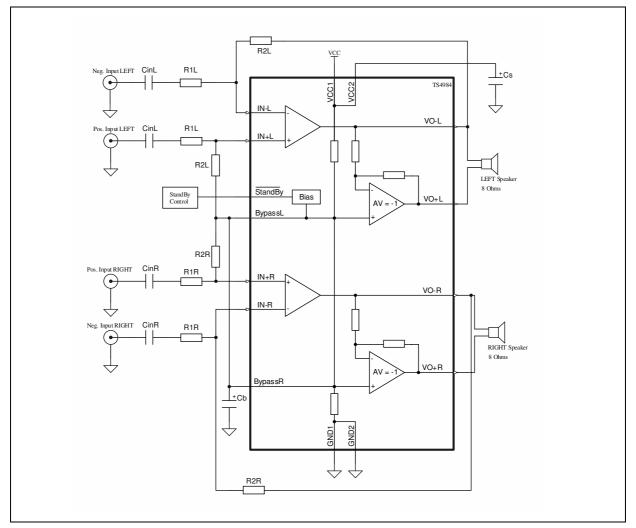
$$R_{1R} = R_{2L} = R_1, R_{2R} = R_{2L} = R_2$$
$$C_{inR} = C_{inL} = C_{in}$$

The gain of the amplifier is:

$$Gvdif = 2 \times \frac{R2}{R1}$$

In order to reach the optimal performance of the differential function, R_1 and R_2 should be matched at 1% maximum.

Figure 69: Differential input amplifier configuration



Application Information

The value of the input capacitor C_{IN} can be calculated with the following formula, using the -3dB lower frequency required (where F_L is the lower frequency required):

$$C_{IN} \approx \frac{1}{2 \pi R_1 F_L} (F)$$

Note: This formula is true only if:

$$F_{CB} = \frac{1}{2\pi (R_1 + R_2) C_B} (Hz)$$

is 5 times lower than F_L .

The following bill of materials is provided as an example of a differential amplifier with a gain of 2 and a -3 dB lower cut-off frequency of about 80 Hz.

Designator	Part Type
$R_{1L} = R_{1R}$	20kΩ / 1%
$R_{2L} = R_{2R}$	20kΩ / 1%
$C_{inR} = C_{inL}$	100nF
$C_b = C_S$	1µF
U1	TS4984

Table 7: Example of a bill of material

TS4984

4.10 Demoboard

A demoboard for the TS4984 is available.

For more information about this demoboard, please refer to **Application Note AN2049**, which can be found on **www.st.com**.

Figure 70 shows the schematic of the demoboard. *Figure 71*, *Figure 72* and *Figure 73* show the component locations, top layer and bottom layer respectively.

Figure 70: Demoboard schematic

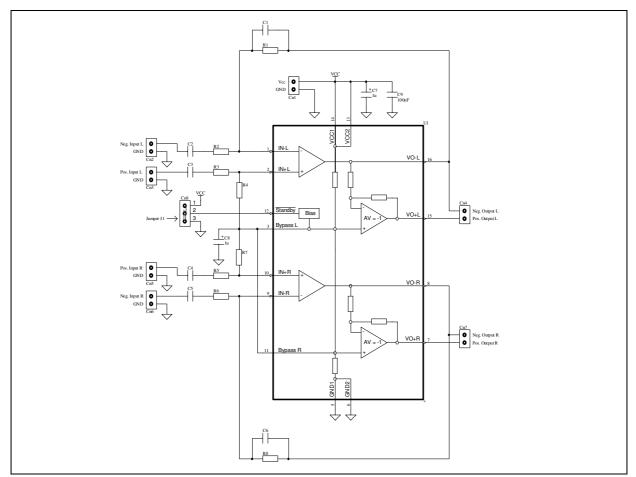


Figure 71: Components location

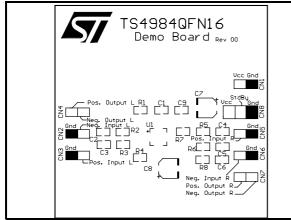


Figure 73: Bottom layer

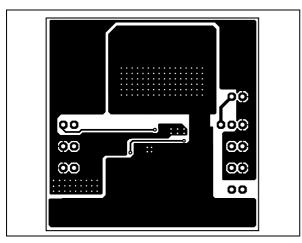
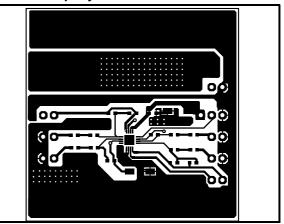


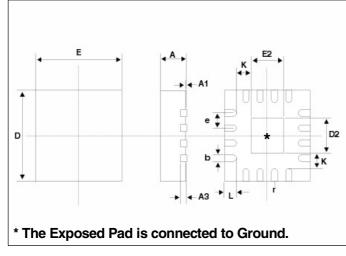
Figure 72: Top layer



TS4984

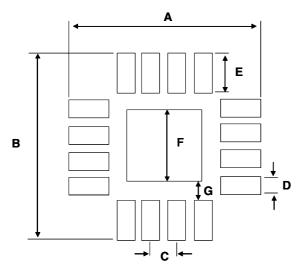
5 Package Mechanical Data

5.1 Dimensions of QFN16 package



DIMENSIONS				
REF	mm			
NEF	MIN.	TYP.	MAX.	
Α	0.8	0.9	1.0	
A1		0.02	0.05	
A3		0.20		
b	0.18	0.25	0.30	
D	3.85	4.0	4.15	
D2	2.1		2.6	
E	3.85	4.0	4.15	
E2	2.1		2.6	
е		0.50		
K	0.2			
L	0.30	0.40	0.50	
r	0.11			

5.2 Footprint recommended data



FOOTPRINT DATA			
mm			
Α	5.0		
В	5.0		
С	0.5		
D	0.35		
E	0.45		
F	2.70		
G	0.22		

Revision History 6

Date	Revision	Description of Changes
01 Jan 2005	1	First Release

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